



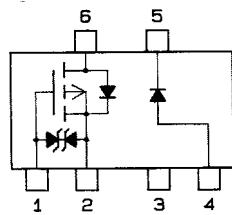
FX851

MOSFET:P-Channel Silicon MOSFET
SBD:Schottky Barrier Diode

DC-DC Converter Applications

Features

- Composite type composed of a low ON-resistance P-channel MOSFET for ultrahigh-speed switching and low-voltage driving and a fast-recovery, low forward-voltage Schottky barrier diode. Facilitates high-density mounting.
- The FX851 is formed with 2 chips, one being equivalent to the 2SJ187 and the other the SB07-03P, placed in one package.

Electrical Connection

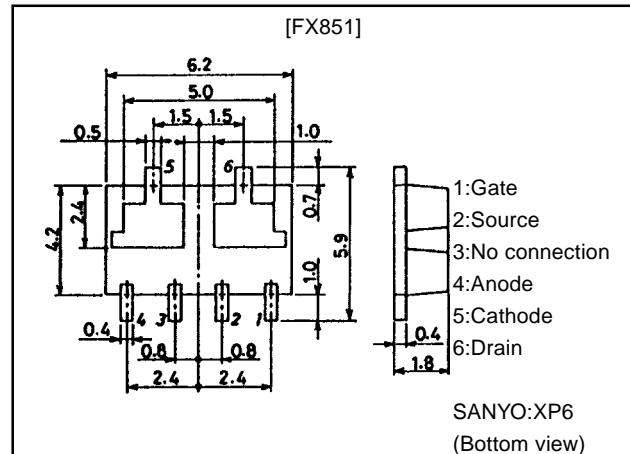
- 1:Gate
2:Source
3:No connection
4:Anode
5:Cathode
6:Drain

(Top view)

Package Dimensions

unit:mm

2119

**Specifications****Absolute Maximum Ratings at Ta = 25°C**

Parameter	Symbol	Conditions	Ratings	Unit
[MOSFET]				
Drain-to-Source Voltage	V _{DSS}		-30	V
Gate-to-Source Voltage	V _{GSS}		±15	V
Drain Current (DC)	I _D		-1	A
Drain Current (Pulse)	I _{DP}	PW≤10μs, duty cycle≤1%	-4	A
Allowable Power Dissipation	P _D	T _c =25°C	6	W
	P _D	Mounted on ceramic board (750mm ² ×0.8mm)	1.5	W
Channel Temperature	T _{ch}		150	°C
Storage Temperature	T _{stg}		-55 to +150	°C
[SBD]				
Repetitive Peak Reverse Voltage	V _{RRM}		30	V
Non-repetitive Peak Reverse Surge Voltage	V _{RSM}		35	V
Average Rectified Current	I _O		700	mA
Surge Forward Current	I _{FSM}	50Hz sine wave, 1 cycle	5	A
Junction Temperature	T _j		-55 to +125	°C
Storage Temperature	T _{stg}		-55 to +150	°C

· Marking:851

Continued on next page.

SANYO Electric Co.,Ltd. Semiconductor Bussiness Headquaters

TOKYO OFFICE Tokyo Bldg., 1-10, 1 Chome, Ueno, Taito-ku, TOKYO, 110-8534 JAPAN

52098HA (KT)/71095MO (KOTO) TA-0119 No.4891-1/4

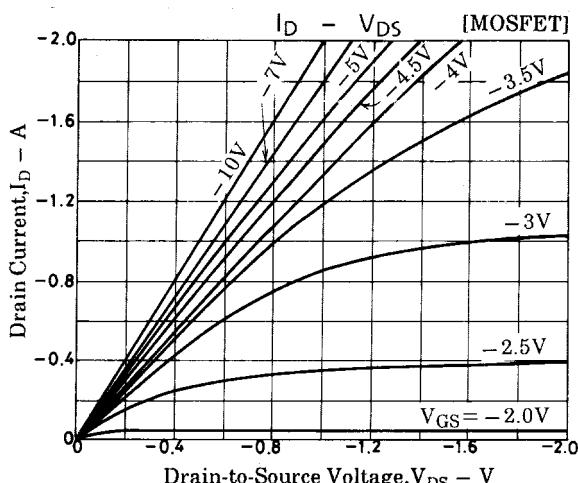
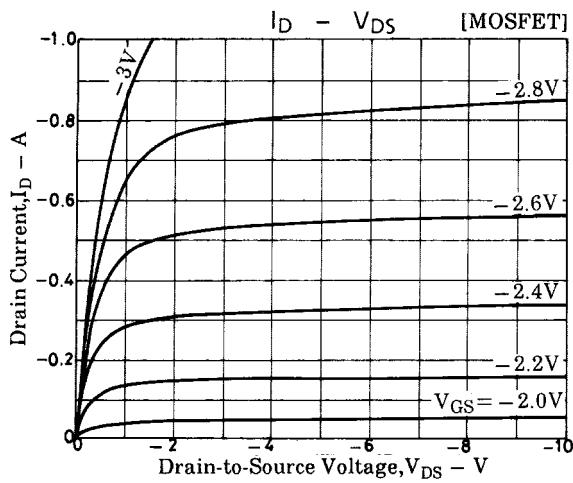
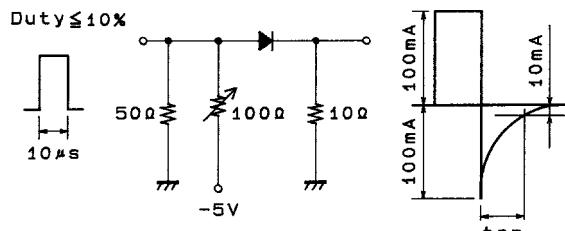
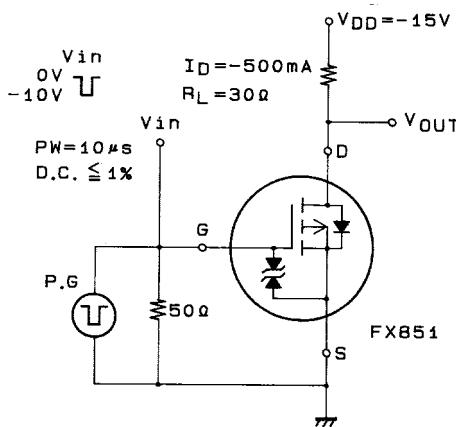
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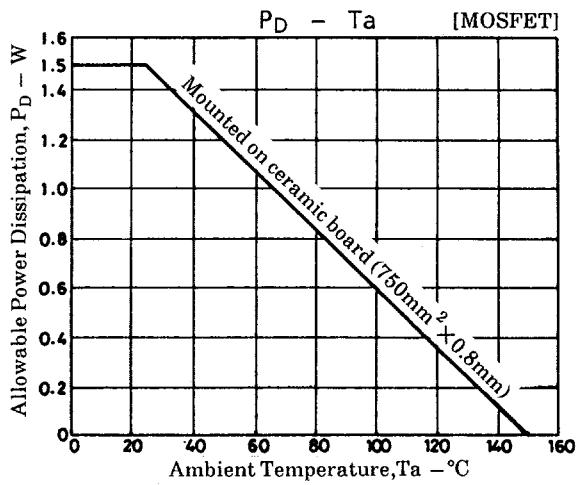
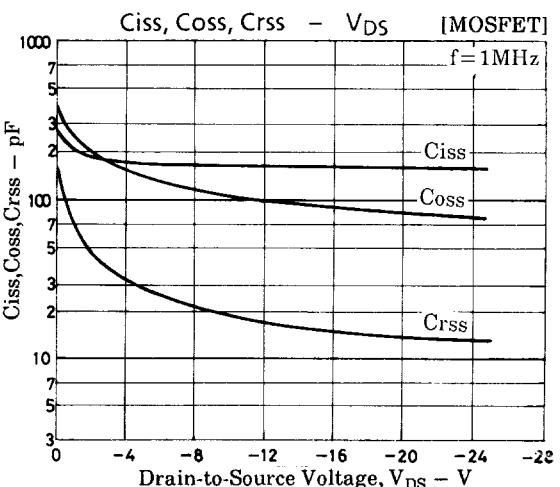
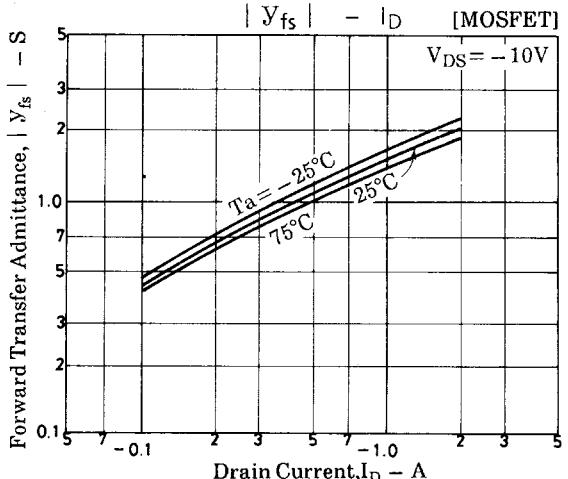
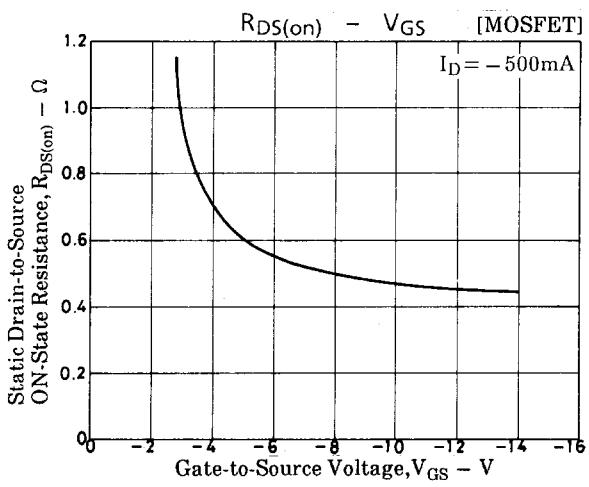
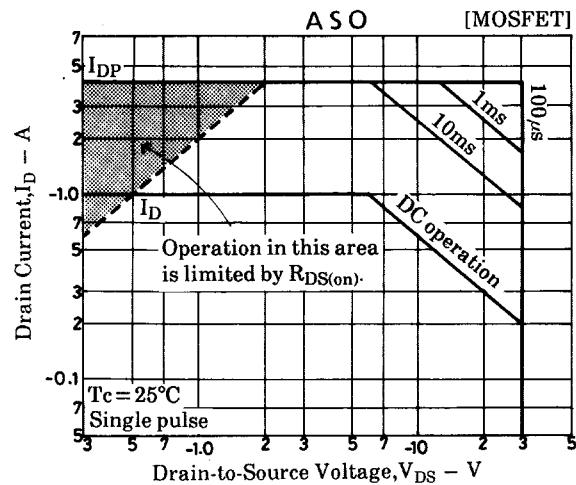
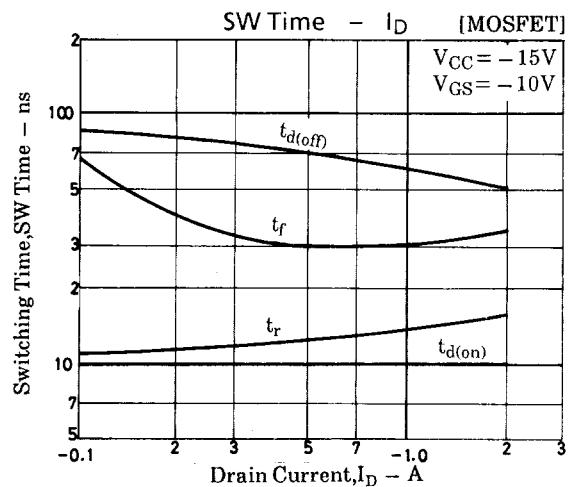
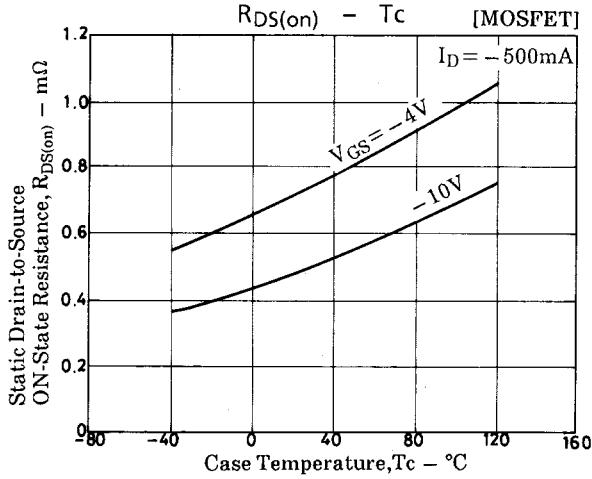
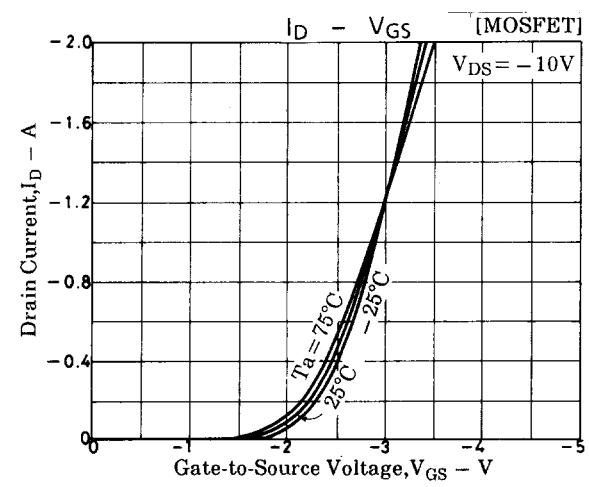
Electrical Characteristics at $T_a = 25^\circ\text{C}$

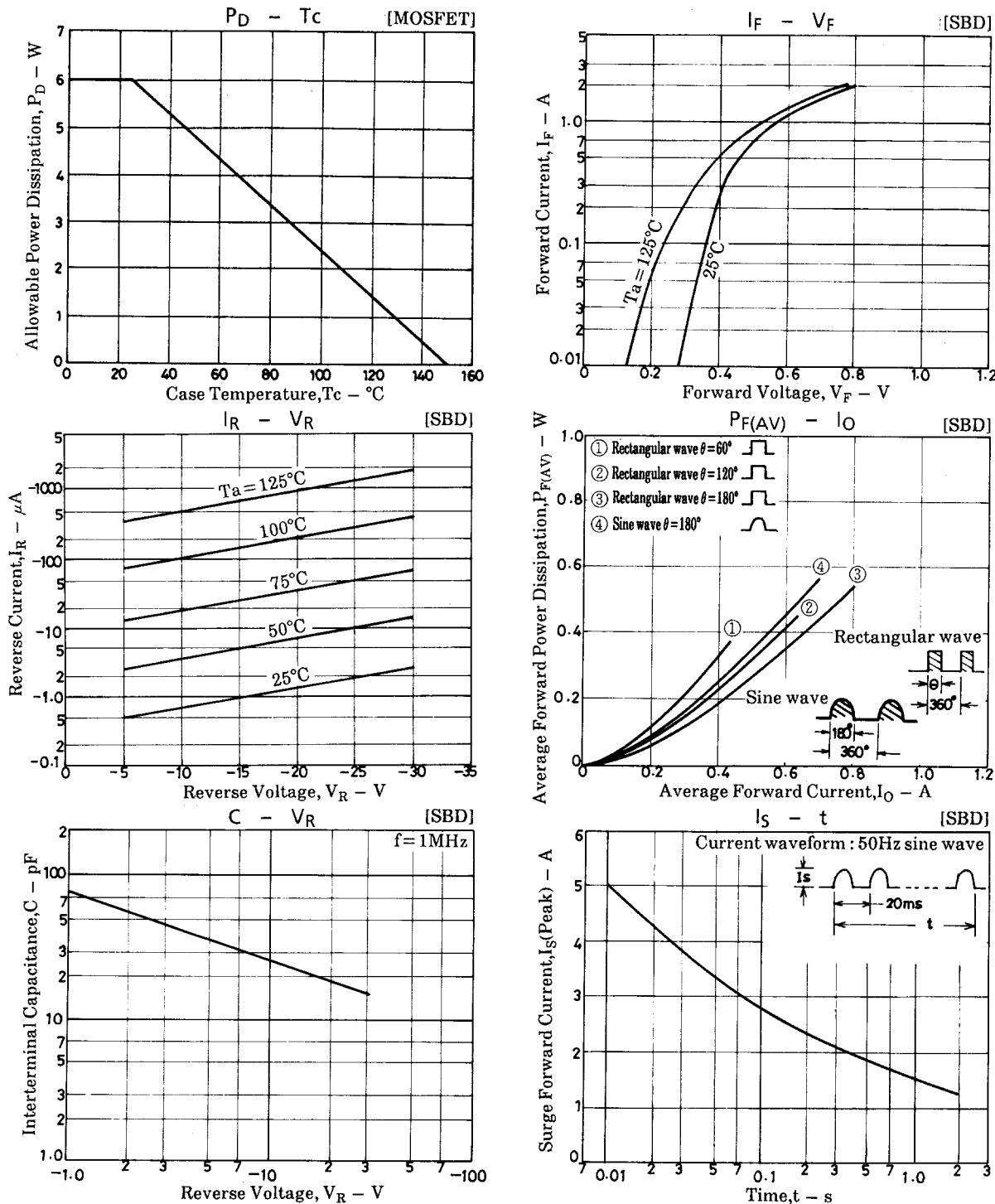
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
[MOSFET]						
D-S Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$I_D=-1\text{mA}, V_{GS}=0$	-30			V
Zero-Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-30\text{V}, V_{GS}=0$			-100	μA
Gate-to-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 12\text{V}, V_{DS}=0$			± 10	μA
Cutoff Voltage	$V_{GS(\text{off})}$	$V_{DS}=-10\text{V}, I_D=1\text{mA}$	-1.0		-2.0	V
Forward Transfer Admittance	$ Y_{fs} $	$V_{DS}=-10\text{V}, I_D=500\text{mA}$	0.6	1.0		S
Static Drain-to-Source ON-State Resistance	$R_{\text{DS(on)}}$	$I_D=500\text{mA}, V_{GS}=-10\text{V}$		0.5	0.75	Ω
	$R_{\text{DS(on)}}$	$I_D=500\text{mA}, V_{GS}=-4\text{V}$		0.75	1.1	Ω
Input Capacitance	C_{iss}	$V_{DS}=-10\text{V}, f=1\text{MHz}$	170			pF
Output Capacitance	C_{oss}	$V_{DS}=-10\text{V}, f=1\text{MHz}$	110			pF
Reverse Transfer Capacitance	C_{rss}	$V_{DS}=-10\text{V}, f=1\text{MHz}$	20			pF
Turn-ON Delay Time	$t_{d(\text{on})}$	See specified Test Circuit	10			ns
Rise Time	t_r	See specified Test Circuit	13			ns
Turn-OFF Delay Time	$t_{d(\text{off})}$	See specified Test Circuit	70			ns
Fall Time	t_f	See specified Test Circuit	30			ns
Diode Forward Voltage	V_{SD}	$I_S=-1\text{A}, V_{GS}=0$	-0.9			V
[SBD]						
Reverse Voltage	V_R	$I_R=300\mu\text{A}$	30			V
Forward Voltage	V_F	$I_F=700\text{mA}$			0.55	V
Reverse Current	I_R	$V_R=15\text{V}$			80	μA
Interterminal Capacitance	C	$V_R=10\text{V}, f=1\text{MHz}$ Cycle	26			pF
Reverse Recovery Time	t_{rr}	$I_F=I_R=100\text{mA}$, See specified Test Circuit			10	ns
Thermal Resistance	$R_{\text{thj-a}}$	Mounted on ceramic board ($750\text{mm}^2 \times 0.8\text{mm}$)	100			$^\circ\text{C/W}$

Switching Time Test Circuit

[MOSFET] **Tr_r Test Circuit** [SBD]







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